

NCEP40T11G

NCE N-Channel Super Trench Power MOSFET

Description

The NCEP40T11G uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

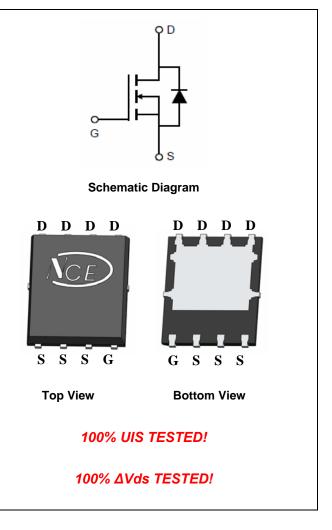
General Features

V_{DS} =40V,I_D =110A
R_{DS(ON)}=2.4mΩ (typical) @ V_{GS}=10V
R_{DS(ON)}=3.3mΩ (typical) @ V_{GS}=4.5V

- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP40T11G	NCEP40T11G	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (T_c=25[°]C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	40	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous (Silicon Limited)	Ι _D	110	А
Drain Current-Continuous(Tc=100℃)	I _D (100℃)	77.8	А
Pulsed Drain Current (Package Limited)	I _{DM}	340	А
Maximum Power Dissipation	PD	75	W
Derating factor		0.6	W/°C
Single pulse avalanche energy (Note 5)	E _{AS}	500	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 150	°C







Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	R _{θJC}	1.67	°C/W
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Electrical Characteristics (Tc=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			-			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	40		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.2	1.7	2.2	V
Durain Course On Chata Desistance	P	V _{GS} =10V, I _D =55A	-	2.4	2.8	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =55A	-	3.3	3.9	mΩ
Forward Transconductance	g fs	V _{DS} =5V,I _D =55A	-	60	-	S
Dynamic Characteristics (Note4)	····					
Input Capacitance	C _{lss}		-	3510	4200	PF
Output Capacitance	Coss	V _{DS} =20V,V _{GS} =0V, F=1.0MHz	-	860	1000	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0WHZ	-	60	78	PF
Switching Characteristics (Note 4)						L
Turn-on Delay Time	t _{d(on)}		-	10.5	-	nS
Turn-on Rise Time	tr	V _{DD} =20V,I _D =55A	-	4	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =1.6 Ω	-	35	-	nS
Turn-Off Fall Time	t _f		-	5	-	nS
Total Gate Charge	Qg		-	60	72	nC
Gate-Source Charge	Q _{gs}	$V_{DS}=20V, I_{D}=55A,$	-	9.9		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	9.5		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =55A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	110	А
Reverse Recovery Time	t _{rr}	T_J = 25°C, I_F = I_S	-		24	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-		68	nC

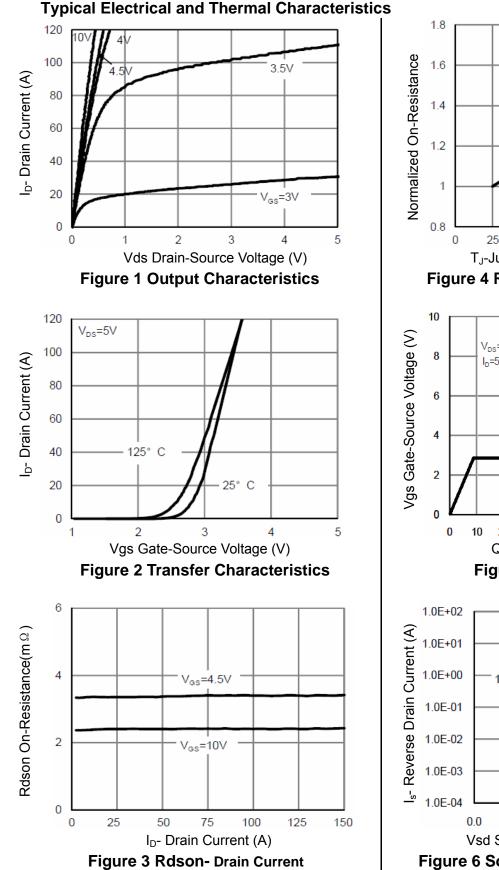
Notes:

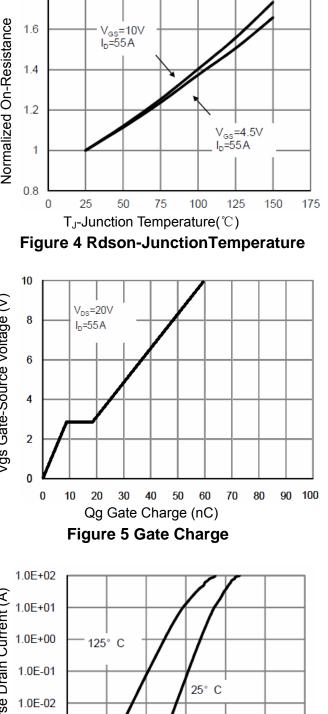
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t \leq 10 sec.
- 3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^\circ \!\! C$,V_{DD}=20V,V_G=10V,L=0.5mH,Rg=25 $\!\Omega$



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0.4

0.6

0.8

1.0

1.2

0.2



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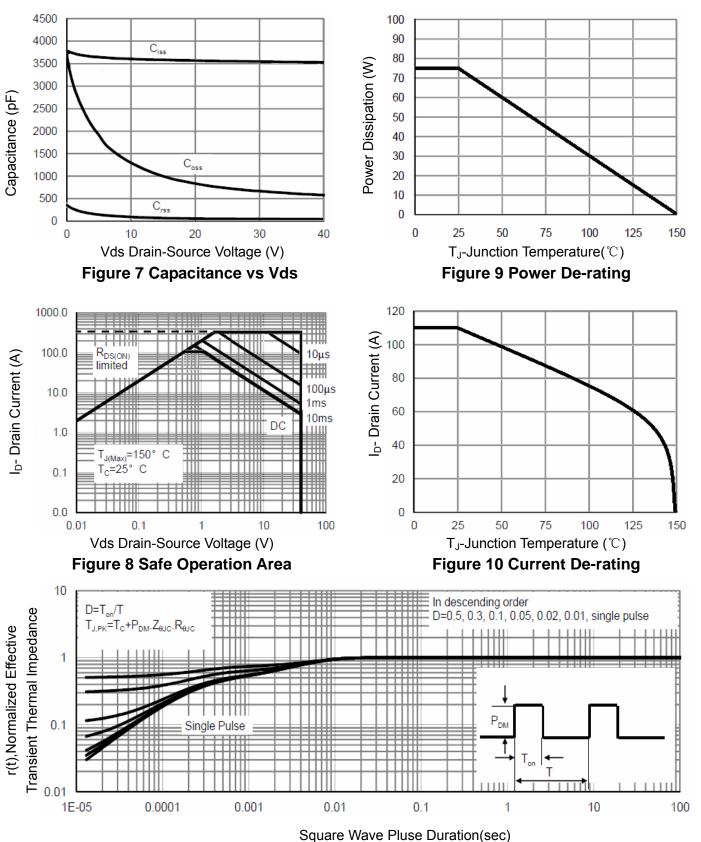


Figure 11 Normalized Maximum Transient Thermal Impedance

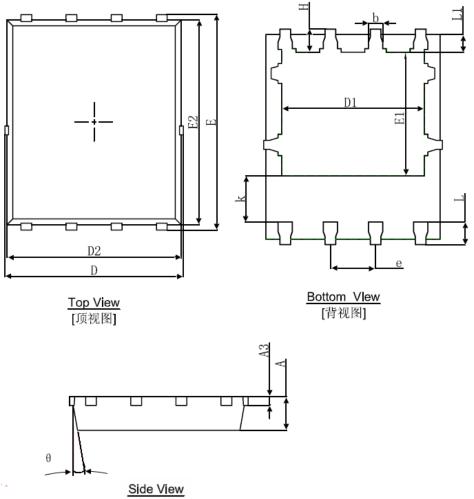


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Pb Free Product

NCEP40T11G

DFN5X6-8L Package Information



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1.524	1/14	J

Cumela e l	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	0.900	1.000	0.035	0.039	
A3	0.254REF.		0.010	REF.	
D	4.944	5.096	0.195	0.201	
E	5.974	6.126	0.235	0.241	
D1	3.910	4.110	0.154	0.162	
E1	3.375	3.575	0.133	0.141	
D2	4.824	4.976	0.190	0.196	
E2	5.674	5.826	0.223	0.229	
k	1.190	1.390	0.047	0.055	
b	0.350	0.450	0.014	0.018	
e	1.270TYP.		0.050	TYP.	
L	0.559	0.711	0.022	0.028	
L1	0.424	0.576	0.017	0.023	
Н	0.574	0.726	0.023	0.029	
θ	8°	12°	8°	12°	







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